

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1987	257/e21.503.cxr.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/03/09 15:33
S1	2031	multilayer adj wiring adj board	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/03/09 12:25
S2	863	S1 and insulating same wiring	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/09/07 15:31
S3	1	"20020127839"	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/09/07 15:32
S4	79	electrode same via adj hole same electroplat\$3	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2005/09/07 15:33
S5	3	((("20020127839") or ("6365513") or ("5258094")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/03/09 15:02
S6	1040	257/e21.597.cxr. 257/e23.011.cxr.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/03/09 15:33
S7	1461	(bury\$3 encapsulat\$3 cover\$3 surround\$3) near6 (parts chip IC integrated adj circuit) and flip adj chip.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/03/09 15:05
S8	616	((bury\$3 encapsulat\$3 cover\$3 surround\$3) near6 (parts chip IC integrated adj circuit) and flip adj chip).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	OFF	2006/03/09 15:06
S9	309	((bury\$3 encapsulat\$3 cover\$3 surround\$3) near6 (parts chip IC integrated adj circuit) and flip adj chip).clm.	USPAT	OR	OFF	2006/03/09 15:22